



**MODULAR APPROVAL
Attestation letter**

May 31, 2022

Timco Engineering, Inc
849 NW State Road 45
Newberry, Florida 32669 - United States

Re: Modular Approval attestation letter
FCC ID: YCP-32WB5MMGH02
IC: 8976A-32WB5MMGH02

Gentlemen,

The **STM32WB5MMGH** meets the requirements for modular approval as detailed in FCC Public notice 15.212 and IC RSS requirements.

Compliance to each of the requirements is described below.

| Clauses | | Manufacturer's arguments Modular Approval |
|---------------------|---------------------------|---|
| 15.212 (a)(1)(i) | Shielding | The module has a metal shield over the radio elements |
| 15.212 (a)(1)(ii) | Buffered Data/Modulation | Chip is compliant with this rule. |
| 15.212 (a)(1)(iii) | Power supply regulation | Chip is compliant with this rule |
| 15.212 (a)(1)(iv) | Antenna | The antenna is permanently attached to the STM32WB5MMGH inside the substrate. |
| 15.212 (a)(1)(v) | Stand-alone configuration | The STM32WB5MMGH was tested in a stand-alone configuration, see "Test setup photos" document. |
| 15.212 (a)(1)(vi) | Label | See "Label" document and exhibition label sample |
| 15.212 (a)(1)(vii) | Operating | The STM32WB5MMGH is compliant with all applicable FCC and IC rules. Details for maintaining compliance are given in the "User Manual". |
| 15.212 (a)(1)(viii) | RF Exposure | The STM32WB5MMGH is compliant with all applicable RF exposure requirements. See "RF exposure" document. |

Please contact me if you have any further question.
Best regards,

JOEL HULOUX

